

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6525468

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TZU-YANG TING	01/06/2021
CHIEH-WEI FENG	01/06/2021
TAI-JUI WANG	01/06/2021
RECEIVING PARTY DATA	
Name:	INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17158014
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NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	01/31/2021
Total Attachments: 2	
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ASSIGNMENT

WHEREAS,

**1.Tzu-Yang Ting
3.Tai-Jui Wang**

2.Chieh-Wei Feng

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **CAPACITOR AND FILTER AND REDISTRIBUTION LAYER STRUCTURE INCLUDING THE SAME**

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, 1. Industrial Technology Research Institute
of 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 310401,
Taiwan, R. O. C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Tzu-Yang Ting Date: 2021.1.6

Sole or First Joint Inventor: **Tzu-Yang Ting**

Signature: Chieh-Wei Feng Date: 2021.1.6

Second Joint Inventor (if any): **Chieh-Wei Feng**

Signature: Tai-Jui Wang Date: 2021.1.6

Third Joint Inventor (if any): **Tai-Jui Wang**